

### Mid-Power LED - 3528 Series

STW9A12D-E3 - 0.2W (Cool, Neutral, Warm)



### **Product Brief**

### Description

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- This White Colored surface-mount LED comes in standard package dimension. Package Size: 3.5x2.8x0.7mm
- It has a substrate made up of a molded plastic reflector sitting on top of a lead frame.
- The die is attached within the reflector cavity and the cavity is encapsulated by silicone.
- The package design coupled with careful selection of component materials allow these products to perform with high reliability.

### **Features and Benefits**

- Market Standard 3528 Package Size
- High Color Quality, CRI Min. 90
- RoHS compliant

### **Key Applications**

- Interior lighting
- General lighting
- Indoor and outdoor displays
- Architectural / Decorative lighting

### Table 1. Product Selection Table

Part Number		ССТ		
Part Number	Color	Min.	Тур.	Max.
STW9A12D-E3	Cool White	4700K	5600K	7000K
STW9A12D-E3	Neutral White	3700K	4200K	4700K
STW9A12D-E3	Warm White	2600K	3000K	3700K





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STW9A12D-E3 – Mid-Power LED

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## **Performance Characteristics**

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	<b>• • •</b> (1)		Luminous	Intensity <sup>[2]</sup>	Luminou	s Flux <sup>[3]</sup>	CRI
Part Number	CCT (K) <sup>[1]</sup>	RANK	I <sub>V</sub> (	cd)	Φ <sub>v</sub> (	R <sub>a</sub>	
	Тур.		Min	Max	Min	Max	Min.
	6500	R5	8.5	9.0	26.4	27.9	90
	0000	S0	9.0	9.5	27.9	29.5	90
	5600	S0	9.0	9.5	27.9	29.5	90
	5600	S5	9.5	10.0	29.5	31.0	90
	5000	S0	9.0	9.5	27.9	29.5	90
	5000	S5	9.5	10.0	29.5	31.0	90
	4500	S0	9.0	9.5	27.5	29.0	90
STW9A12D	4500	S5	9.5	10.0	29.0	30.5	90
-E3	4000	S0	9.0	9.5	27.5	29.0	90
	4000	S5	9.5	10.0	29.0	30.5	90
	2500	S0	9.0	9.5	27.0	28.5	90
	3500	S5	9.5	10.0	28.5	30.0	90
	2000	R5	8.5	9.0	25.5	27.0	90
	3000	S0	9.0	9.5	27.0	28.5	90
	2700	R5	8.5	9.0	25.5	27.0	90
	2700	S0	9.0	9.5	27.0	28.5	90

### Table 2. Product Selection Guide, $I_F = 65mA$ , $T_j = 25^{\circ}C$ , RH30%

### Notes :

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (2) Seoul Semiconductor maintains a tolerance of ±7% on Intensity and power measurements. The luminous intensity IV was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (3) The lumen table is only for reference.



# **Performance Characteristics**

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### Table 3. Characteristics, $I_F$ =65mA, $T_j$ = 25°C, RH30%

Parameter	Symbol		Value			
Farameter	Symbol	Min.	Тур.	Max.	Unit	
Forward Current	I <sub>F</sub>	-	65	-	mA	
Forward Voltage	V <sub>F</sub>	2.8	2.85	3.0	V	
Luminous Intensity <sup>[1]</sup> (5,000K) <sup>[2]</sup>	$I_v$	-	9.8	-	cd	
CRI <sup>[3]</sup>	$R_a$	90	-	-		
Viewing Angle	2Θ <sub>1/2</sub>	-	120	-	Deg.	
Storage Temperature	$T_{stg}$	- 40	-	+ 85	٥C	
Thermal resistance (J to S) <sup>[4]</sup>	Rθ <sub>J-S</sub>	-	15	-	°C/W	

### **Table 4. Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	200	mA
Power Dissipation	P <sub>D</sub>	0.7	W
Junction Temperature	T <sub>j</sub>	125	٥C
Operating Temperature	T <sub>opr</sub>	-40 ~ + 85	٥C
Storage Temperature	T <sub>stg</sub>	-40 ~ + 100	°C

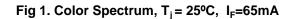
#### Notes :

- (1) Seoul Semiconductor maintains a tolerance of  $\pm 7\%$  on Intensity and power measurements.
- (2) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. Color coordinate :  $\pm 0.005$ , CCT  $\pm 5\%$  tolerance.
- (3) Tolerance is ±2.0 on CRI measurements.
- (4) Thermal resistance is junction to Solder.
- (5)  $I_{FP}$  conditions with pulse width ≤10ms and duty cycle ≤10%
- (6) The products are sensitive to static electricity and must be carefully taken when handling products
- Calculated performance values are for reference only.
- All measurements were made under the standardized environment of Seoul Semiconductor.



# **Characteristics Graph**

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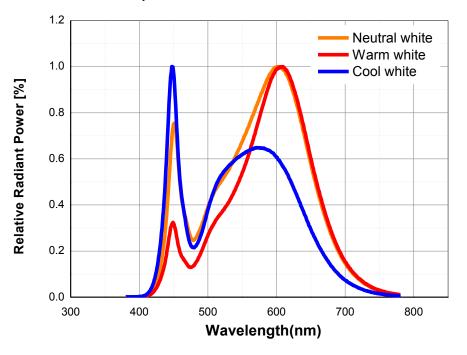
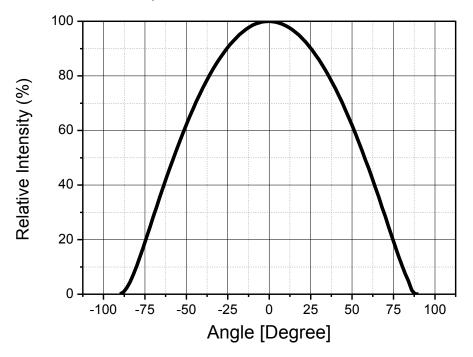


Fig 2. Radiant Pattern, T<sub>j</sub> = 25°C, I<sub>F</sub>=65mA





# **Characteristics Graph**

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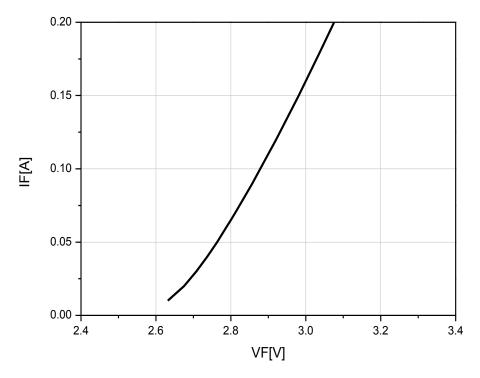
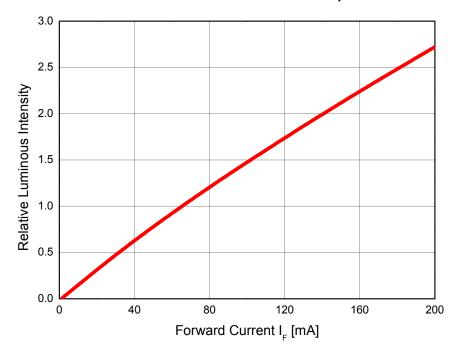


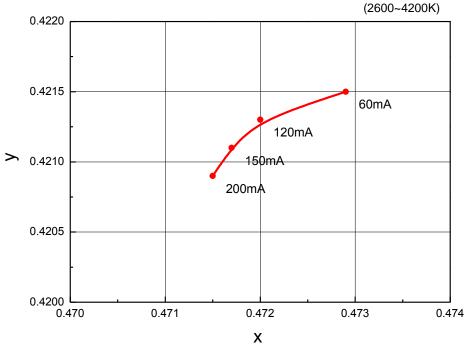
Fig 3. Forward Voltage vs. Forward Current,  $T_j = 25^{\circ}C$ 

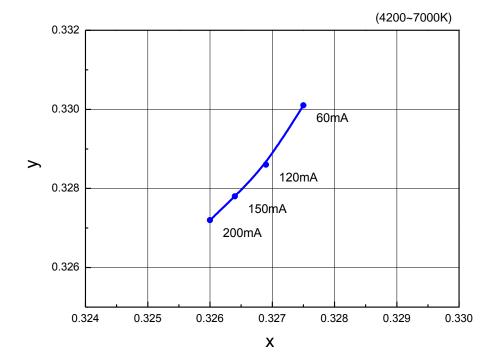
Fig 4. Forward Current vs. Relative Luminous Intensity, T<sub>i</sub> = 25°C





# **Characteristics Graph**







# **Characteristics Graph**

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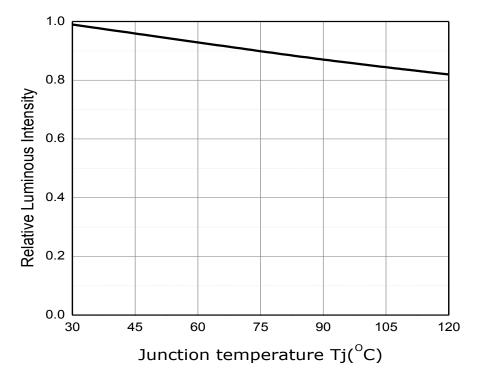
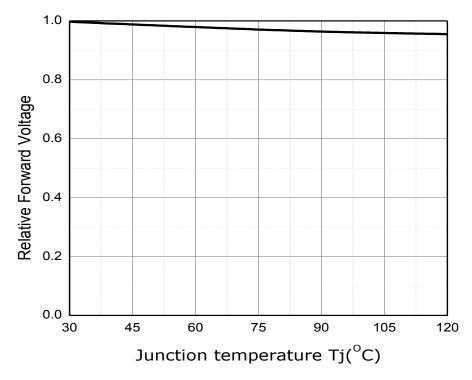


Fig 6. Junction Temperature vs. Relative Luminous Intensity,  $I_F$ =65mA

Fig 7. Junction Temperature vs. Relative Forward Voltage,  $I_F$ =65mA



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# **Characteristics Graph**

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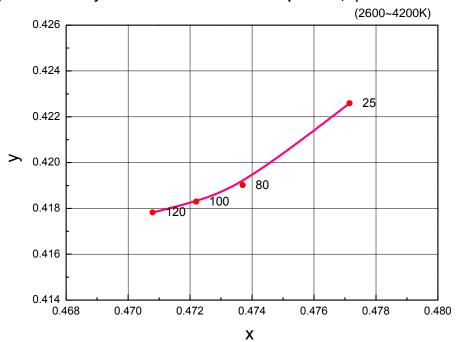
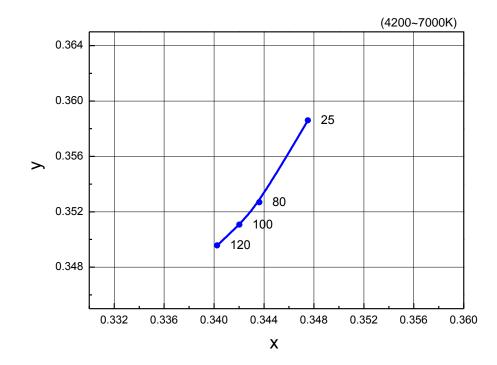
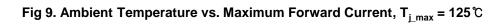


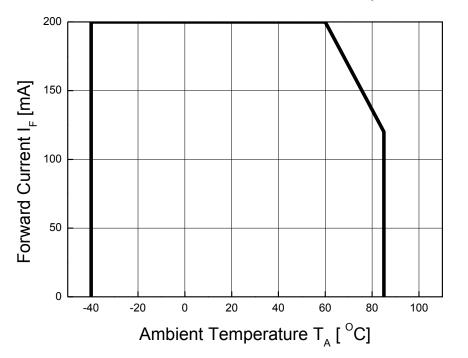
Fig 8. Chromaticity Coordinate vs. Junction Temperature,  $I_F$ =65mA





# **Characteristics Graph**





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# **Color Bin Structure**

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### Table 5. Bin Code description, $T_j=25$ °C, $I_F=65mA$

	Luminc	ous Intensi	ty (cd)	Color	Typical	Typical Forward Voltage (V)Bin CodeMin.Max.Y22.82.9		
Part Number	Bin Code	Min.	Max.	Chromaticity Coordinate		Min.	Max.	
	R5	8.5	9.0		Y2	2.8	2.9	
STW9A12D-E3	S0	9.0	9.5	Refer to page. 12	Y3	2.9	3.0	
	S5 9.5 10.0							

### Table 6. Intensity rank distribution

### Available ranks

	-			
сст	CIE		IV Rank	
6,000 ~ 7,000K	А	R5	SO	S5
5,300 – 6,000K	В	R5	SO	S5
4,700 ~ 5,300K	С	R5	S0	S5
4,200 ~ 4,700K	D	R5	S0	S5
3,700 ~ 4,200K	E	R5	SO	S5
3,200 ~ 3,700K	F	R5	SO	S5
2,900 ~ 3,200K	G	R5	SO	S5
2,600 ~ 2,900K	н	R5	SO	S5

#### \*Notes :

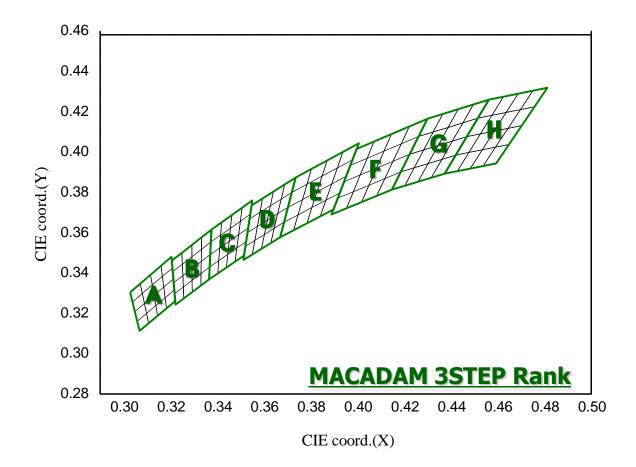
(1) Calculated performance values are for reference only.

All measurements were made under the standardized environment of Seoul Semiconductor.
 In order to ensure availability, single color rank will not be orderable.



# **Color Bin Structure**

CIE Chromaticity Diagram Ti=25℃, IF=65mA



#### \*Notes :

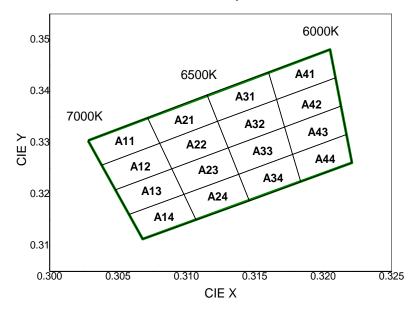
• Energy Star binning applied to all 2600~7000K.

- Measurement Uncertainty of the Color Coordinates :  $\pm \ 0.005$ 

## **Color Bin Structure**

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### CIE Chromaticity Diagram (Cool white), $T_i=25$ °C, $I_F=65$ mA



A1	1	A	21	A3	31	A	¥1
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3028	0.3304	0.3072	0.3349	0.3115	0.3393	0.3160	0.3437
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
0.3072	0.3349	0.3115	0.3393	0.3160	0.3437	0.3205	0.3481
A1	2	A	22	A3	32	A	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3048	0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3089	0.3249	0.3131	0.3290	0.3172	0.3331	0.3213	0.3371
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
A1	3	A	23	A3	33	A	43
			CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X	CIE Y	CIE X				-	-
0.3048	CIE Y 0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
					0.3290 0.3239		0.3331 0.3277
0.3048	0.3209	0.3089	0.3249	0.3131		0.3172	
0.3048	0.3209 0.3161	0.3089 0.3098	0.3249	0.3131 0.3138	0.3239	0.3172 0.3178	0.3277
0.3048 0.3058 0.3098	0.3209 0.3161 0.3200 0.3249	0.3089 0.3098 0.3138 0.3131	0.3249 0.3200 0.3239	0.3131 0.3138 0.3178	0.3239 0.3277 0.3331	0.3172 0.3178 0.3217	0.3277 0.3316 0.3371
0.3048 0.3058 0.3098 0.3089	0.3209 0.3161 0.3200 0.3249	0.3089 0.3098 0.3138 0.3131	0.3249 0.3200 0.3239 0.3290	0.3131 0.3138 0.3178 0.3172	0.3239 0.3277 0.3331	0.3172 0.3178 0.3217 0.3213	0.3277 0.3316 0.3371
0.3048 0.3058 0.3098 0.3089 A1	0.3209 0.3161 0.3200 0.3249 4	0.3089 0.3098 0.3138 0.3131 A	0.3249 0.3200 0.3239 0.3290 24	0.3131 0.3138 0.3178 0.3172 A3	0.3239 0.3277 0.3331 34	0.3172 0.3178 0.3217 0.3213 A4	0.3277 0.3316 0.3371 14
0.3048 0.3058 0.3098 0.3089 A1 CIE X	0.3209 0.3161 0.3200 0.3249 4 CIE Y	0.3089 0.3098 0.3138 0.3131 At CIE X	0.3249 0.3200 0.3239 0.3290 24 CIE Y	0.3131 0.3138 0.3178 0.3172 A3 CIE X	0.3239 0.3277 0.3331 34 CIE Y	0.3172 0.3178 0.3217 0.3213 A4 CIE X	0.3277 0.3316 0.3371 14 CIE Y
0.3048 0.3058 0.3098 0.3089 A1 CIE X 0.3058	0.3209 0.3161 0.3200 0.3249 4 CIE Y 0.3161	0.3089 0.3098 0.3138 0.3131 A CIE X 0.3098	0.3249 0.3200 0.3239 0.3290 24 CIE Y 0.3200	0.3131 0.3138 0.3178 0.3172 A3 CIE X 0.3138	0.3239 0.3277 0.3331 34 CIE Y 0.3239	0.3172 0.3178 0.3217 0.3213 A2 CIE X 0.3178	0.3277 0.3316 0.3371 44 CIE Y 0.3277

## **Color Bin Structure**

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#### 5300K 0.36 5600K B41 B31 0.35 6000K B42 B21 B32 B11 ≻ ≝0.34 B43 B22 B33 B12 B44 B23 B34 B13 B24 0.33 B14 0.32 0.325 0.330 0.335 0.340 CIE X

Bí	11	B	21	B3	31	B	41	
CIE X	CIE Y							
0.3207	0.3462	0.3250	0.3501	0.3292	0.3539	0.3334	0.3578	
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554	
0.3250	0.3501	0.3292	0.3539	0.3334	0.3578	0.3376	0.3616	
B	12	B	22	B3	32	B4	42	
CIE X	CIE Y							
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	
0.3215	0.3353	0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	
0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	0.3371	0.3493	
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554	
B1	13	B	23	B3	3	B4	B43	
CIE X	CIE Y							
0.3215	0.3353	0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	
0.3218	0.3298	0.3256	0.3331	0.3294	0.3364	0.3331	0.3398	
0.3256	0.3331	0.3294	0.3364	0.3331	0.3398	0.3369	0.3431	
0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	0.3371	0.3493	
B1	14	B	24	B3	34	B4	14	
CIE X	CIE Y							
0.3218	0.3298	0.3256	0.3331	0.3294	0.3364	0.3331	0.3398	
0.3222	0.3243	0.3258	0.3275	0.3294	0.3306	0.3330	0.3338	
0.3258	0.3275	0.3294	0.3306	0.3330	0.3338	0.3366	0.3369	
0.3256	0.3331	0.3294	0.3364	0.3331	0.3398	0.3369	0.3431	

### CIE Chromaticity Diagram (Cool white), $T_i=25$ °C, $I_F=65mA$

# **Color Bin Structure**

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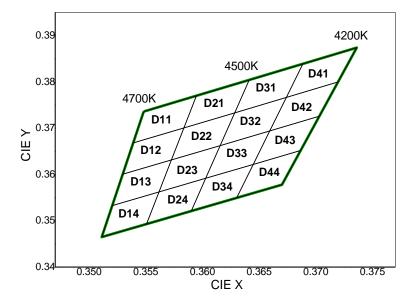
#### 0.38 4700K 5000K C41 0.37 C31 5300K C42 C21 ≻ <sup>0.36</sup> ≝ C11 C32 C22 C43 C12 C33 C23 C44 0.35 C13 C34 C24 C14 0.34 0.340 0.345 0.350 0.355 0.335 CIE X

C	11	C	21	C	31	C4	41
CIE X	CIE Y						
0.3376	0.3616	0.3420	0.3652	0.3463	0.3687	0.3507	0.3724
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
0.3420	0.3652	0.3463	0.3687	0.3507	0.3724	0.3551	0.3760
C	12	C	22	C	32	C	42
CIE X	CIE Y						
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3411	0.3525	0.3452	0.3558	0.3492	0.3591	0.3533	0.3624
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
C	13	C	23	C33		C43	
CIE X	CIE Y						
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3369	0.3431	0.3407	0.3462	0.3446	0.3493	0.3485	0.3524
0.3407	0.3462	0.3446	0.3493	0.3485	0.3524	0.3523	0.3555
0.3411	0.3525	0.3452	0.3558	0.3492	0.3591	0.3533	0.3624
C	14	C	24	C	34	C	14
CIE X	015 14		015.14		CIE Y	CIE X	CIE Y
	CIE Y	CIE X	CIE Y	CIE X	CIE I		-
0.3369	0.3431	0.3407	0.3462	0.3446	0.3493	0.3485	0.3524
-							0.3524 0.3458
0.3369	0.3431	0.3407	0.3462	0.3446	0.3493	0.3485	

### CIE Chromaticity Diagram (Cool white), $\, T_{j} {=} 25\, ^{\circ} \!\! C \, , \, I_{F} {=} 65 mA$

## **Color Bin Structure**

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### CIE Chromaticity Diagram (Neutral white), $T_i=25$ °C, $I_F=65$ mA

D1	11	D	21	D	31	D	41	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.3548	0.3736	0.3595	0.3770	0.3641	0.3804	0.3689	0.3839	
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800	
0.3595	0.3770	0.3641	0.3804	0.3689	0.3839	0.3736	0.3874	
D	12	D	22	D	32	D	42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	
0.3530	0.3601	0.3573	0.3632	0.3616	0.3663	0.3659	0.3694	
0.3573	0.3632	0.3616	0.3663	0.3659	0.3694	0.3703	0.3726	
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800	
			D23 D33				CIE Y 0.3839 0.3767 0.3800 0.3874 42 CIE Y 0.3767 0.3694 0.3726 0.3800 43 CIE Y 0.3694 0.3694 0.3692 0.3652 0.3652 0.3726 44 CIE Y 0.3622	
D1	13	D	23	D	33	D4	43	
D1 CIE X	13 CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X		
							CIE Y	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y 0.3694	
CIE X 0.3530	CIE Y 0.3601	CIE X 0.3573	CIE Y 0.3632	CIE X 0.3616	CIE Y 0.3663	CIE X 0.3659	CIE Y 0.3694 0.3622	
CIE X 0.3530 0.3520	CIE Y 0.3601 0.3533	CIE X 0.3573 0.3562	CIE Y 0.3632 0.3562	CIE X 0.3616 0.3603	CIE Y 0.3663 0.3592	CIE X 0.3659 0.3645	CIE Y 0.3694 0.3622 0.3652	
CIE X 0.3530 0.3520 0.3562	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592	CIE X 0.3616 0.3603 0.3645	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687	CIE Y 0.3694 0.3622 0.3652 0.3726	
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726	
CIE X 0.3530 0.3520 0.3562 0.3573 D <sup>*</sup>	CIE Y 0.3601 0.3533 0.3562 0.3632 14	CIE X 0.3573 0.3562 0.3603 0.3616 D	CIE Y 0.3632 0.3562 0.3592 0.3663 24	CIE X 0.3616 0.3603 0.3645 0.3659 D3	CIE Y 0.3663 0.3592 0.3622 0.3694 34	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726 14 CIE Y	
CIE X 0.3530 0.3520 0.3562 0.3573 D' CIE X	CIE Y 0.3601 0.3533 0.3562 0.3632 14 CIE Y	CIE X 0.3573 0.3562 0.3603 0.3616 D CIE X	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y	CIE X 0.3616 0.3603 0.3645 0.3659 D3 CIE X	CIE Y 0.3663 0.3592 0.3622 0.3694 34 CIE Y	CIE X 0.3659 0.3645 0.3687 0.3703 D4 CIE X	CIE Y 0.3694 0.3622 0.3652 0.3726 14 CIE Y	
CIE X 0.3530 0.3520 0.3562 0.3573 D' CIE X 0.3520	CIE Y 0.3601 0.3533 0.3562 0.3632 14 CIE Y 0.3533	CIE X 0.3573 0.3562 0.3603 0.3616 D CIE X 0.3562	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y 0.3562	CIE X 0.3616 0.3603 0.3645 0.3659 D3 CIE X 0.3603	CIE Y 0.3663 0.3592 0.3622 0.3694 34 CIE Y 0.3592	CIE X 0.3659 0.3645 0.3687 0.3703 D4 CIE X 0.3645	CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y 0.3622	



# **Color Bin Structure**

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#### 0.41 3700K 0.40 4000K E41 E31 4200K E42 E21 0.39 E32 E11 ≻ 巴 0.38 E22 E43 E12 E33 E23 E44 E13 E34 0.37 **E24** E14 0.36 0.35 0.38 0.40 0.37 0.39 CIE X

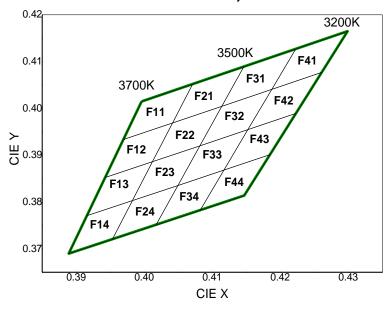
E1	11	E	21	E3	31	E4	41
CIE X	CIE Y						
0.3736	0.3874	0.3804	0.3917	0.3871	0.3959	0.3939	0.4002
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3804	0.3917	0.3871	0.3959	0.3939	0.4002	0.4006	0.4044
E1	12	E	22	E3	32	E4	42
CIE X	CIE Y						
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3703	0.3726	0.3765	0.3765	0.3828	0.3803	0.3890	0.3842
0.3765	0.3765	0.3828	0.3803	0.3890	0.3842	0.3952	0.3880
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
E1	13	E	23	E3	33	E4	43
CIE X	CIE Y						
0.3703	0.3726	0.3765	0.3765	0.3828	0.3803	0.3890	0.3842
0.3687	0.3652	0.3746	0.3689	0.3806	0.3725	0.3865	0.3762
0.3746	0.3689	0.3806	0.3725	0.3865	0.3762	0.3925	0.3798
0.3765	0.3765	0.3828	0.3803	0.3890	0.3842	0.3952	0.3880
E1	14	E	24	E3	34	E4	14
CIE X	CIE Y						
0.3687	0.3652	0.3746	0.3689	0.3806	0.3725	0.3865	0.3762
0.3670	0.3578	0.3727	0.3613	0.3784	0.3647	0.3841	0.3682
0.3727	0.3613	0.3784	0.3647	0.3841	0.3682	0.3898	0.3716
0.3746	0.3689	0.3806	0.3725	0.3865	0.3762	0.3925	0.3798

### CIE Chromaticity Diagram (Neutral white), $T_i=25$ °C, $I_F=65$ mA



# **Color Bin Structure**

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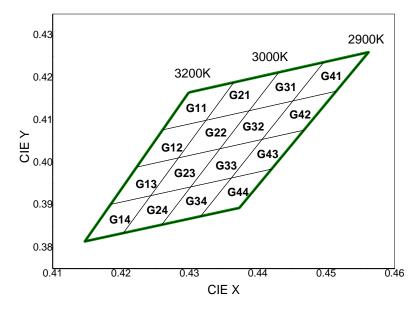
# CIE Chromaticity Diagram (Warm white), $T_i=25$ °C, $I_F=65$ mA

F11		F21		F31		F41		
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.3996	0.4015	0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077	
0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	0.4299	0.4165	
F1	F12		F22		F32		F42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	
0.3943	0.3853	0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	
0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	0.4223	0.3990	
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077	
			011000	0.1101	011011	0	011011	
F1	3	F		F3		F4		
F1 CIE X	3 CIE Y							
		F	23	F3	3	F4	13	
CIE X	CIE Y	F: CIE X	23 CIE Y	F3 CIE X	CIE Y	F4 CIE X	I3 CIE Y	
CIE X 0.3943	CIE Y 0.3853	CIE X 0.4012	23 CIE Y 0.3886	F3 CIE X 0.4082	CIE Y 0.3920	CIE X 0.4152	I3 CIE Y 0.3955	
CIE X 0.3943 0.3916	CIE Y 0.3853 0.3771	CIE X 0.4012 0.3983	CIE Y 0.3886 0.3803	F3 CIE X 0.4082 0.4049	CIE Y 0.3920 0.3836	CIE X 0.4152 0.4117	L3 CIE Y 0.3955 0.3869	
CIE X 0.3943 0.3916 0.3983	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049	CIE Y 0.3886 0.3803 0.3836 0.3920	F3 CIE X 0.4082 0.4049 0.4117	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185	L3 CIE Y 0.3955 0.3869 0.3902 0.3990	
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920	F3 CIE X 0.4082 0.4049 0.4117 0.4152	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223	L3 CIE Y 0.3955 0.3869 0.3902 0.3990	
CIE X 0.3943 0.3916 0.3983 0.4012 F1	CIE Y 0.3853 0.3771 0.3803 0.3886 4	CIE X 0.4012 0.3983 0.4049 0.4082	23 CIE Y 0.3886 0.3803 0.3836 0.3920 24	F3 CIE X 0.4082 0.4049 0.4117 0.41152 F3	3         CIE Y         0.3920         0.3836         0.3869         0.3955         4	F2 CIE X 0.4152 0.4117 0.4185 0.4223 F2	<ul> <li>CIE Y</li> <li>0.3955</li> <li>0.3869</li> <li>0.3902</li> <li>0.3990</li> </ul>	
CIE X 0.3943 0.3916 0.3983 0.4012 F1 CIE X	CIE Y 0.3853 0.3771 0.3803 0.3886 4 CIE Y	CIE X 0.4012 0.3983 0.4049 0.4082 F2 CIE X	23 CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y	CIE X 0.4082 0.4049 0.4117 0.4152 F3 CIE X	CIE Y 0.3920 0.3836 0.3869 0.3955 4 CIE Y	CIE X 0.4152 0.4117 0.4185 0.4223 F <sup>2</sup> CIE X	43 CIE Y 0.3955 0.3869 0.3902 0.3990 44 CIE Y	
CIE X 0.3943 0.3916 0.3983 0.4012 F1 CIE X 0.3916	CIE Y 0.3853 0.3771 0.3803 0.3886 4 CIE Y 0.3771	CIE X 0.4012 0.3983 0.4049 0.4082 CIE X 0.3983	23 CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y 0.3803	CIE X         0.4082         0.4049         0.4117         0.4152         F3         CIE X         0.4049	3 CIE Y 0.3920 0.3836 0.3869 0.3955 4 CIE Y 0.3836	CIE X 0.4152 0.4117 0.4185 0.4223 F4 CIE X 0.4117	I3         CIE Y         0.3955         0.3869         0.3902         0.3990         I4         CIE Y         0.3869	



# **Color Bin Structure**

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### CIE Chromaticity Diagram (Warm white), $T_1=25$ °C, $I_F=65mA$

G11		G21		G31		G41		
CIE X	CIE Y							
0.4299	0.4165	0.4364	0.4188	0.4430	0.4212	0.4496	0.4236	
0.4261	0.4077	0.4324	0.4099	0.4387	0.4122	0.4451	0.4145	
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4514	0.4168	
0.4365	0.4189	0.4430	0.4212	0.4496	0.4236	0.4562	0.4260	
G	G12		G22		G32		G42	
CIE X	CIE Y							
0.4261	0.4077	0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	
0.4223	0.3990	0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	
0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	0.4468	0.4077	
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4515	0.4168	
G1	13	G	23	G	33	G4	43	
CIE X	CIE Y							
0.4223	0.3990	0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	
0.4185	0.3902	0.4243	0.3922	0.4302	0.3943	0.4361	0.3964	
0.4243	0.3922	0.4302	0.3943	0.4361	0.3964	0.4420	0.3985	
0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	0.4468	0.4077	
G14		G24		G34		G44		
CIE X	CIE Y							
0.4243	0.3922	0.4302	0.3943	0.4302	0.3943	0.4361	0.3964	
0.4203	0.3834	0.4259	0.3853	0.4259	0.3853	0.4316	0.3873	
0.4147	0.3814	0.4203	0.3834	0.4316	0.3873	0.4373	0.3893	
0.4185	0.3902	0.4243	0.3922	0.4361	0.3964	0.4420	0.3985	

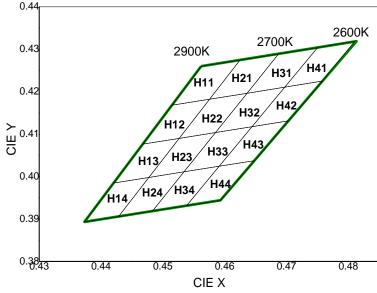


CIE Chromaticity Diagram (Warm white), T<sub>i</sub>=25℃, I<sub>F</sub>=65mA

STW9A12D-E3 – Mid-Power LED

# **Color Bin Structure**

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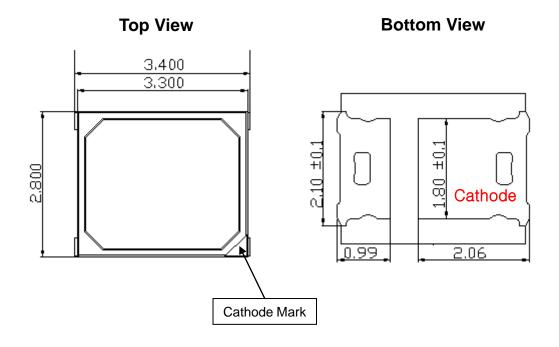
#### H11 H41 H21 H31 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4562 0.4260 0.4625 0.4275 0.4687 0.4289 0.4750 0.4304 0.4515 0.4168 0.4575 0.4636 0.4211 0.4182 0.4197 0.4697 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4758 0.4225 0.4625 0.4275 0.4687 0.4289 0.4750 0.4304 0.4810 0.4319 H12 H22 H32 H42 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4515 0.4168 0.4575 0.4182 0.4636 0.4211 0.4197 0.4697 0.4077 0.4526 0.4090 0.4585 0.4468 0.4104 0.4644 0.4118 0.4526 0.4090 0.4585 0.4104 0.4644 0.4118 0.4703 0.4132 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4758 0.4225 H13 H23 H33 H43 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4077 0.4526 0.4468 0.4090 0.4585 0.4104 0.4644 0.4118 0.4420 0.3985 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4477 0.4534 0.4591 0.3998 0.4012 0.4025 0.4648 0.4038 0.4526 0.4090 0.4585 0.4104 0.4644 0.4118 0.4703 0.4132 H14 H24 H34 H44 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4420 0.3985 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4373 0.3893 0.4428 0.3906 0.4483 0.3919 0.4538 0.3932 0.4428 0.3906 0.4483 0.3919 0.4538 0.3932 0.4593 0.3944 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4648 0.4038

Rev1.1, May 29, 2018



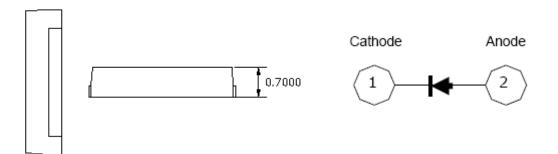
# **Mechanical Dimensions**

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**Side View** 

Circuit

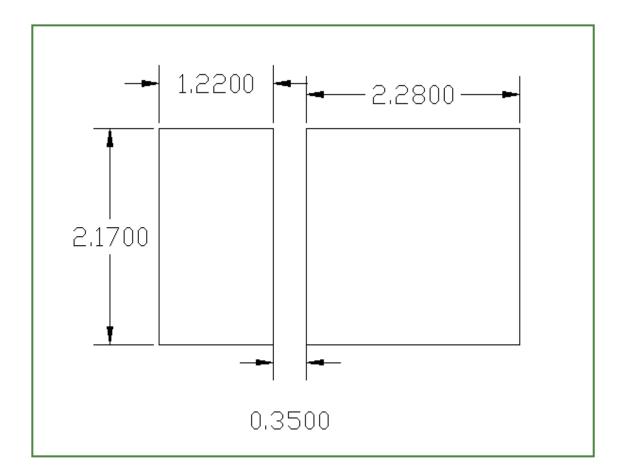


### Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) Undefined tolerance is  $\pm 0.2 \text{mm}$



### **Recommended Solder Pad**



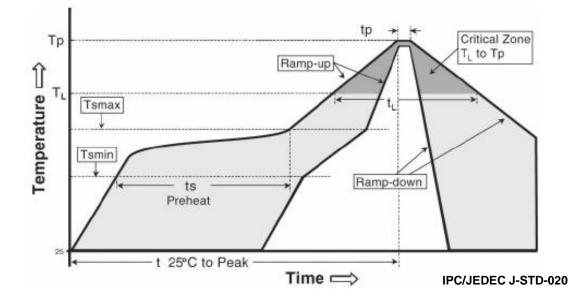
### Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is  $\pm 0.1$ mm
- (5) The appearance and specifications of the product may be changed for improvement without notice.

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STW9A12D-E3 – Mid-Power LED

# **Reflow Soldering Characteristics**



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate $(T_{s\_max} \text{ to } T_p)$	3° C/second max.	3° C/second max.
Preheat - Temperature Min (T <sub>s_min</sub> ) - Temperature Max (T <sub>s_max</sub> ) - Time (T <sub>s_min</sub> to T <sub>s_max</sub> ) (t <sub>s</sub> )	100 ℃ 150 ℃ 60-120 seconds	150 ℃ 200 ℃ 60-180 seconds
Time maintained above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (T <sub>p</sub> )	<b>215</b> ℃	<b>260</b> ℃
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

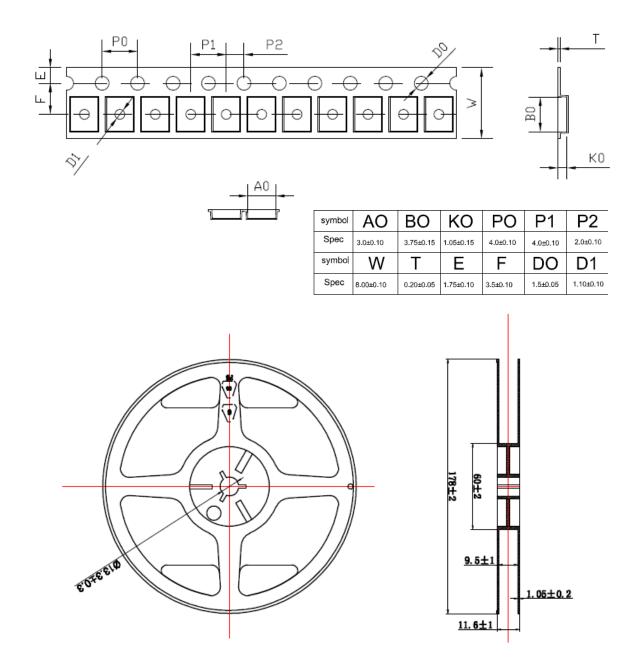
### **Caution :**

- Reflow soldering is recommended not to be done more than two times In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.



STW9A12D-E3 – Mid-Power LED

# **Emitter Tape & Reel Packaging**



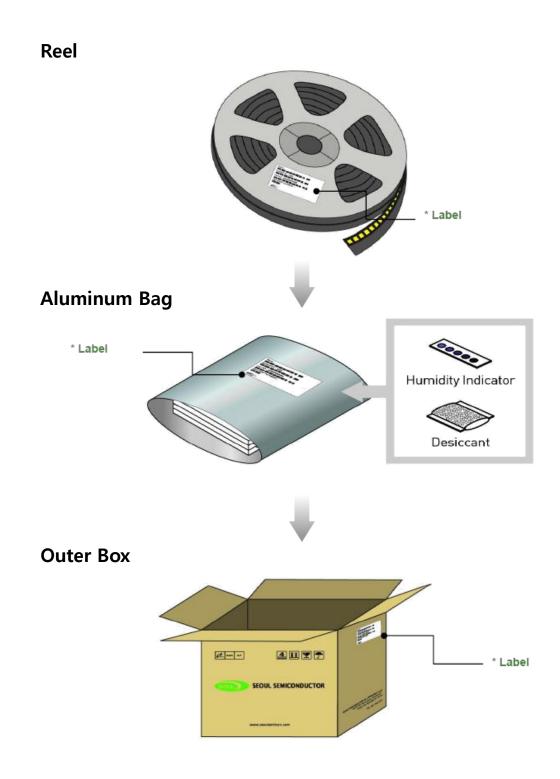
### Notes :

- (1) Quantity : Max 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm$ 0.2mm
- (3) Adhesion Strength of Cover Tape
- Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.
- (4) Package : P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package.



STW9A12D-E3 – Mid-Power LED

# **Emitter Tape & Reel Packaging**



# **Product Nomenclature**

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Part Number Code	Description	Part Number	Value
<b>X</b> <sub>1</sub>	Company	S	
X <sub>2</sub>	Top View LED series	Т	
X <sub>3</sub> X <sub>4</sub>	Color Specification	W9	CRI 90
X <sub>5</sub>	Package series	А	A series
X <sub>6</sub> X <sub>7</sub>	Characteristic code	12	
X <sub>8</sub>	Version	D	
X <sub>9</sub> X <sub>10</sub>	Internal code	E3	

### Table 8. Lot Numbering System $:Y_1Y_2Y_3Y_4Y_5Y_6Y_7Y_8Y_9Y_{10}-Y_{11}Y_{12}Y_{13}Y_{14}Y_{15}Y_{16}Y_{17}$

Lot Number Code	Description	Lot Number	Value
Y <sub>1</sub> Y <sub>2</sub>	Year		
Y <sub>3</sub>	Month		
Y <sub>4</sub> Y <sub>5</sub>	Day		
Y <sub>6</sub>	Top View LED series		
Y <sub>7</sub> Y <sub>8</sub> Y <sub>9</sub> Y <sub>10</sub>	Mass order		
$Y_{11}Y_{12}Y_{13}Y_{14}Y_{15}Y_{16}Y_{17}$	Internal Number		



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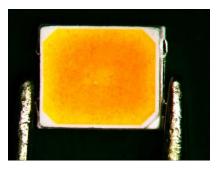
STW9A12D-E3 – Mid-Power LED

# Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



(2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



(3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.

(4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust.

As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.

(5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.

(6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this. product with acid or sulfur material in sealed space.

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#### STW9A12D-E3 – Mid-Power LED

# **Precaution for Use**

#### (1) Storage

To avoid the moisture penetration, we recommend store in a dry box with a desiccant. The recommended storage temperature range is 5  $^{\circ}$ C to 30  $^{\circ}$ C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use SMT techniques properly when you solder the LED as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
  - Sealing
  - Temperature : 5 ~ 30  $^\circ\!\! C$  Humidity : less than RH60%
- b. If the package has been opened more than 4 week(MSL\_2a) or the color of the desiccant changes, components should be dried for 10-24hr at  $65\pm5$  °C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication.These products are dangerous if they are burned or shredded in the process of disposal.It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.



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- (10) The appearance and specifications of the product may be modified for improvement without notice.
- (11) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (12) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (13) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (14) The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- (15) Similar to most Solid state devices;

LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)

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STW9A12D-E3 – Mid-Power LED

# **Precaution for Use**

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package

(If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)

- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package
- (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.

c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:

- A surge protection circuit
- An appropriately rated over voltage protection device
- A current limiting device



# **Company Information**

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#### **Company Information**

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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